

**SURFACE MOUNT GLASS PASSIVATED  
FAST RECOVERY SILICON RECTIFIER**  
**VOLTAGE RANGE 50 to 1000 Volts CURRENT 3.0 Amperes**

**FEATURES**

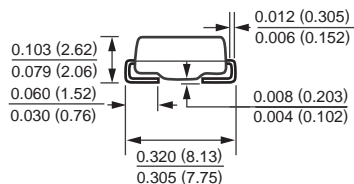
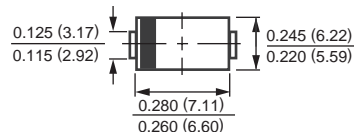
- \* Glass passivated device
- \* Ideal for surface mounted applications
- \* Low leakage current
- \* Metallurgically bonded construction
- \* Mounting position: Any
- \* Weight: 0.24 gram

**MECHANICAL DATA**

- \* Epoxy : Device has UL flammability classification 94V-0



**DO-214AB**



Dimensions in inches and (millimeters)

**MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS**

Ratings at 25 °C ambient temperature unless otherwise specified.  
Single phase, half wave, 60 Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

**MAXIMUM RATINGS** (At TA = 25°C unless otherwise noted)

RATINGS	SYMBOL	FFM301	FFM302	FFM303	FFM304	FFM305	FFM306	FFM307	UNITS
Maximum Recurrent Peak Reverse Voltage	VRRM	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	VRMS	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	VDC	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current at TA = 55°C	IO				3.0				Amps
Peak Forward Surge Current 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	IFSM				200				Amps
Maximum Thermal Resistance	(Note 2) RθJL				15				°C/W
	(Note 3) RθJA				50				°C/W
Typical Junction Capacitance (Note 1)	CJ				60				pF
Operating and Storage Temperature Range	TJ, TSTG				-55 to + 150				°C

**ELECTRICAL CHARACTERISTICS** (At TA = 25°C unless otherwise noted)

CHARACTERISTICS	SYMBOL	FFM301	FFM302	FFM303	FFM304	FFM305	FFM306	FFM307	UNITS
Maximum Forward Voltage at 3.0A DC	VF				1.3				Volts
Maximum Full Load Reverse Current, Full cycle Average at TA=55°C	IR				50				uAmps
Maximum DC Reverse Current at @TA = 25°C					10				uAmps
Rated DC Blocking Voltage @TA = 125°C					300				uAmps
Maximum Reverse Recovery Time (Note 4)	trr				150	250	500		nSec

- NOTES : 1. Measured at 1.0 MHz and applied average voltage of 4.0VDC  
 2. Thermal resistance junction to terminal 6.0mm<sup>2</sup> copper pads to each terminal.  
 3. Thermal resistance junction to ambient, 6.0mm<sup>2</sup> copper pads to each terminal.  
 4. Test Conditions: IF = 0.5A, IR = -1.0A, IRR = -0.25A

# RATING AND CHARACTERISTIC CURVES ( FFM301 THRU FFM307 )

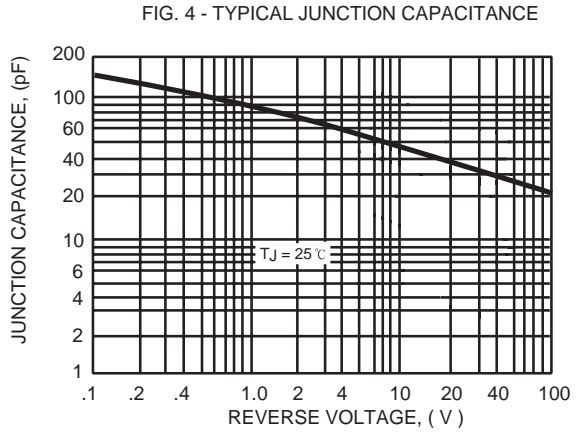
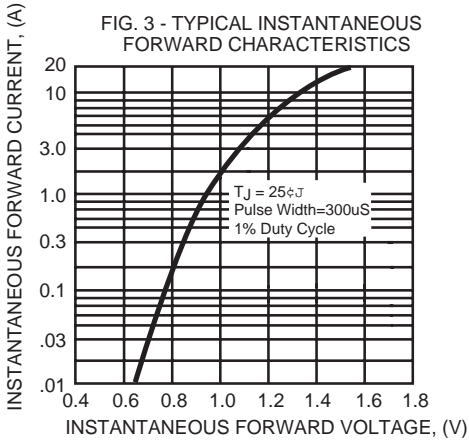
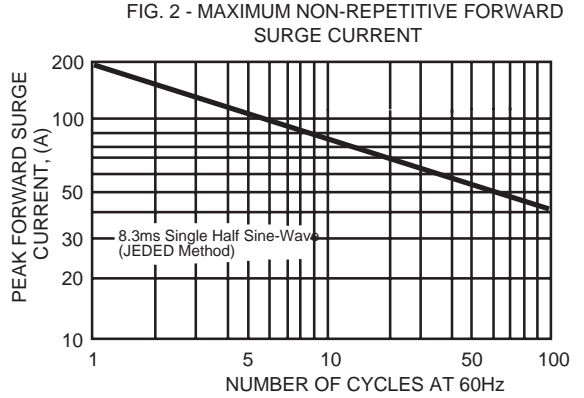
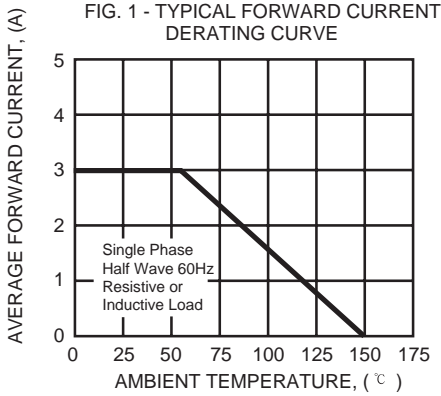
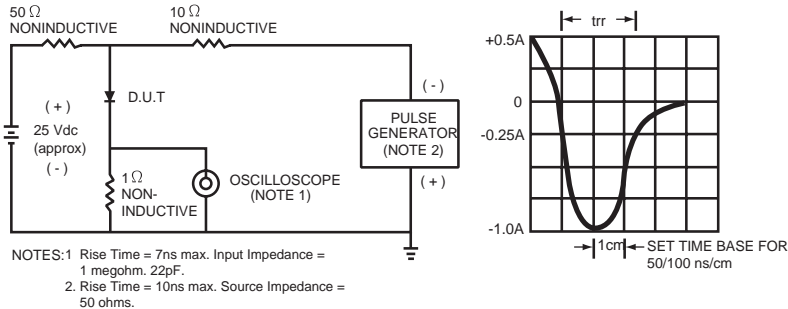
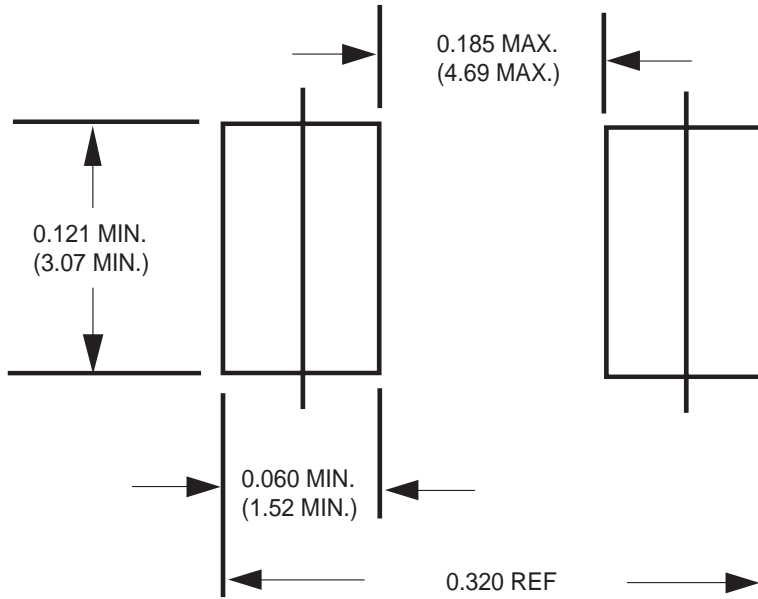


FIG. 5 - TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC



## Mounting Pad Layout



Dimensions in inches and (millimeters)